Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
				Form Type Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materia				rials and N	als and Mfg Information				
upplier Information														
Company name* Cor			Company unique ID			Unique ID Authority				Respon	Response Date*			
nsemi										2025-07-13				
ontact Name Title - Contact			ct		Phone - Contact*					Email - Contact*				
Product-Env-Stewards Product Enviro			riro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Authorized Representative* Title - Representative			entative		Phone - Representative*			Email ·	Email - Representative*					
Product-Env-Stewards Proc			Product Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Requester Item Number	Mfr Item	n Number	Mfr Item Name			Effective Date	ective Date Version Manufacturing Site		Ianufacturing Site		Weight*	UOM	Unit Type	
	FAN486	AN48610UC50X 3MHZ DC/DC Bo		oost 1.0A		2025-07-13		P	РВВ		1.8869	mg	Each	
Ianufacturing Proccess Informa	ation													
Terminal Plating / Grid Array M	erminal Plating / Grid Array Material Terminal Base Allo		Alloy	J-STD-020 MSL Rating		Peak Process Body Temperature Max T		e Max Time at Peal	Peak Temperature		ber of Reflow Cyc	eles		
SnAgCu CU Alloy			1		260		С	30	seco	nds 3				
omments														
vel 1 - maximum time at peak temperat	ure during so	ldering is 10-3	0 seconds											
or more information regarding materia	l composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Backside Protection Film	0.0721	mg		Epoxy resin	proprietary data		0.0151	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0013	mg
			Supplier	Acrylic resins	Proprietary Data		0.0151	mg
			Supplier	Silica (SiO2)	14464-46-1		0.0406	mg
Die	1.1356	mg	Supplier	Silicon (Si)	7440-21-3		1.1294	mg
			Supplier	Aluminum (Al)	7429-90-5		0.0062	mg
Solder Ball	0.5417	mg	Supplier	Silver (Ag)	7440-22-4		0.0217	mg
			Supplier	Tin (Sn)	7440-31-5		0.5173	mg
			Supplier	Copper (Cu)	7440-50-8		0.0027	mg
Under Bump Metal	0.1375	mg	Supplier	Titanium (Ti)	7440-32-6		0.0009	mg
			Supplier	Copper (Cu)	7440-50-8		0.1366	mg